502660636 01/31/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2707243

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MASATAKA SATOH	01/29/2014
KOUKI HIRANO	01/29/2014
HITOSHI HORITA	01/29/2014
MASANOBU ITO	01/14/2014

RECEIVING PARTY DATA

Name:	HITACHI METALS, LTD.	
Street Address:	2-1, SHIBAURA 1-CHOME MINATO-KU	
City:	токуо	
State/Country:	JAPAN	
Postal Code:	105-8614	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14169214	

CORRESPONDENCE DATA

Fax Number: (703)848-2981 Phone: 703-584-3270

Email: tcole@rmsclaw.com, ttyler@rmsclaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: ROBERTS MLOTKOWSKI SAFRAN & COLE, P.C.

Address Line 1: 7918 JONES BRANCH DRIVE

Address Line 2: SUITE 500

Address Line 4: MCLEAN, VIRGINIA 22102-8064

ATTORNEY DOCKET NUMBER:	743065-146	
NAME OF SUBMITTER:	THOMAS W. COLE	

PATENT 502660636 REEL: 032101 FRAME: 0612

Signature: /Thomas W. Cole/	
Date: 01/31/2014	
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 4 source=PHCF-13128US_AssignDec#page1 source=PHCF-13128US_AssignDec#page2 source=PHCF-13128US_AssignDec#page3 source=PHCF-13128US_AssignDec#page4	.tif .tif

PATENT REEL: 032101 FRAME: 0613

ASSIGNMENT - DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	CONNECTOR SUPPORTING STRUCTURE AND CONNECTOR-EQUIPPED ELECTRONIC DEVICE			
	DECLARATION			
As the below name	d inventor, I hereby declare that:			
This declaration is	directed to:			
■ The attached a	application, or			
☐ United States filed on	application or PCT international application number,			
	ed application was made or authorized to be made by me.			
I believe that I am t	he original inventor or an original joint inventor of a claimed invention in the application.			
I hereby state that claims.	I have reviewed and understand the contents of the above-identified specification, including the			
I acknowledge the Federal Regulations	duty to disclose information, which is material to patentability as defined in Title 37, Code of s, 1.56.			
	lge that any willful false statement made in this declaration is punishable under 18 U.S.C. §1001 ment of not more than five (5) years, or both.			
	ASSIGNMENT			
WHEREAS, the undersigned whose post office address and citizenship is indicated below hereinafter referred to as the ASSIGNOR(S), has/have invented a certain improvement relating to the above identified invention				
AND WHEREAS, <u>Hitachi Metals, Ltd.</u> whose post-office address is <u>2-1, Shibaura 1-chome Minato-ku, Tokyo, 105-8614, Japan</u> , hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, and prolongations thereof.				
acknowledged, said representatives, the United States and e and all Letters Pa thereunder, said As invention and appli which may be grant powers, privileges, of any and all such for the use and ber	TTNESSETH that, for good and valuable consideration the receipt whereof is hereby d ASSIGNOR(S) hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal entire and exclusive right, title and interest in and to said invention and application, for the lsewhere throughout the world including any and all divisions and continuations thereof, and any tent which may be granted therefor and all rights to sue for past and future infringement SSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said cation, including any and all divisions and continuations thereof, and any and all Letters Patent ted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, and advantages in any ways arising from or pertaining thereto, for and during the term or terms Letters Patent when granted, including any and all renewals, reissues, and prolongations thereof, nefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial as and purposes as the said ASSIGNOR(S) might or could have held and enjoyed the same, if this been made.			

AND said ASSIGNOR(S) hereby agree to execute all papers necessary to file applications in the United States and elsewhere throughout the world for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNOR(S) authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

LEGAL NAME OF INVENTOR(S)			
Inventor one:	Masataka SATOH	Date:	2 9 JAN 2014
Signature:	Masataka Sato		
Inventor two:	Kouki HIRANO	Date:	2 9 JAN 2014
Signature:	Mohi Nirano		
Inventor three:	Hitoshi HORITA	Date:	
Signature:			
Inventor four:	Masanobu ITO	Date:	
Signature:			
Inventor five:		Date:	
Signature:			
Inventor six:	·	Date:	
Signature:			
Inventor seven:		Date:	
Signature:			
Inventor eight:		Date:	
Signature:			
Inventor nine:		Date:	
Signature:			

Roberts Mlotkowski Safran & Cole, P.C., Suite 500 7918 Jones Branch Drive McLean, Virginia 22102

AND said ASSIGNOR(S) hereby agree to execute all papers necessary to file applications in the United States and elsewhere throughout the world for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

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LEGAL NAME OF INVENTOR(S)			
Inventor one:	Masataka SATOH	Date:	
Signature:			
Inventor two:	Kouki HIRANO	Date:	
Signature:			
Inventor three:	Hitoshi HORITA		
Signature:	Hitohi Horita		
Inventor four:	Masanobu ITO	Date:	
Signature:			· · · · · · · · · · · · · · · · · · ·
Inventor five:		Date:	
Signature:			
Inventor six:		Date:	
Signature:		· · · · · · · · · · · · · · · · · · ·	
Inventor seven:		Date:	
Signature:			
Inventor eight:		Date:	
Signature:			
Inventor nine:		Date:	
Signature:			

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Signature: